# Dual N-Channel 40 V (D-S) MOSFET

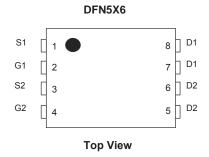
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}$ (m $\Omega$ )(Typ.)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
40	6.6 at V <sub>GS</sub> = 10 V	40	13.5 nC			
40	8.7 at V <sub>GS</sub> = 4.5 V	40	13.3110			

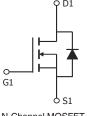
#### **FEATURES**

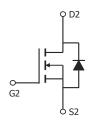
- DT-Trench Power MOSFET
- 100 % Rg and UIS tested
- Low on-resistance RDS(on)

#### **APPLICATIONS**

- DC/DC Converter
- · Ideal for high-frequency switching and synchronous rectification







N-Channel MOSFET

N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V <sub>DS</sub>	40	V			
Gate-Source Voltage	V <sub>GS</sub>	± 20	V			
Continuous Dunin Comment (T., 150 90)	T <sub>C</sub> = 25 °C	I-	40	А		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>C</sub> = 100 °C	I <sub>D</sub>	28			
Pulsed Drain Current <sup>b</sup>	I <sub>DM</sub>	160				
Single Avalanche Energy	E <sub>AS</sub>	72	mJ			
Maximum Bawar Dissinations	T <sub>C</sub> = 25 °C	В	25	W		
Maximum Power Dissipation <sup>c</sup>	T <sub>C</sub> = 100 °C	P <sub>D</sub>	10			
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-Ambient (PCB Mount) <sup>d</sup>			°C/W		
Junction-to-Case (Drain)	R <sub>thJC</sub>	5	]		

- a. Calculated continuous current based on maximum allowablejunction temperature.
- b. Repetitive rating; pulse width limited by max. junction temperature.
- c. Pd is based on max. junction temperature, using junction-case thermal resistance.
- d. The value of R<sub>0JA</sub> is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper,in a still air environment with Ta=25 °C.



PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40	-	-	V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	3		
Gate-Body Leakage	$I_{GSS}$ $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 40  V$ , $V_{GS} = 0  V$	-	-	1	μA	
Zero Gate Voltage Drain Gunerit	I <sub>DSS</sub>	$V_{DS}$ = 32 V, $V_{GS}$ = 0 V, $T_J$ = 125 °C	-	-	100		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40	-	-	Α	
Drain-Source On-State Resistance a	D	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	6.6	8	0	
Dialit-Source Oil-State nesistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		8.7	11	mΩ	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 10 A	-	45	-	S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>		-	808	-	pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 20 \text{ V}, f = 1 \text{ MHz}$	-	314	-		
Reverse Transfer Capacitance	C <sub>rss</sub>		-	6	-		
Total Gate Charge <sup>c</sup>	Qg		-	13.5	-	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	2.5	-		
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$		-	3.3	-		
Gate Resistance	$R_g$	f = 1 MHz	-	5.1	-	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>		-	5.2	-		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, I_D = 10 \text{ A}, R_g = 3\Omega$	-	15	-	- ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	V <sub>GS</sub> = 10 V	-	24.8	-		
Fall Time <sup>c</sup>	t <sub>f</sub>		-	14.5	-		
<b>Drain-Source Body Diode Ratings and</b>	Characterist	ics <sup>b</sup> (T <sub>C</sub> = 25 °C)					
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	40	Α	
Pulsed Current	I <sub>SM</sub>		-	-	160	Α	
Forward Voltage <sup>a</sup>	$V_{SD}$	I <sub>F</sub> = 1 A, V <sub>GS</sub> = 0 V	-	-	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>	L = 10 A di/dt = 100 A/···	-	12	-	ns	
Reverse Recovery Charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	-	23	-	nC	

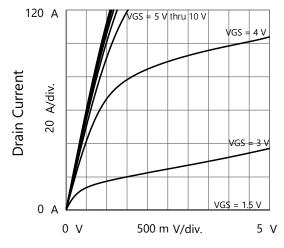
#### Notes

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

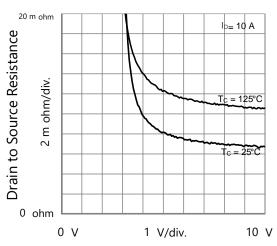
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



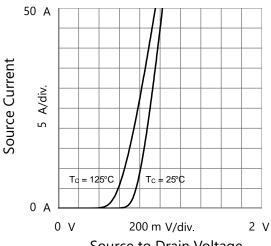
### **TYPICAL CHARACTERISTICS** (T<sub>C</sub> = 25 °C, unless otherwise noted)



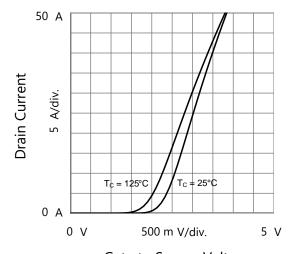
Drain to Source Voltage Output Characteristics



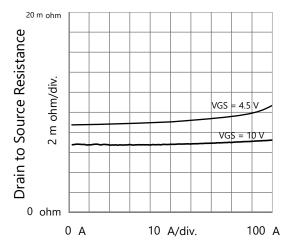
Gate to Source Voltage
Drain to Source Resistance vs. Gate to Source Voltage



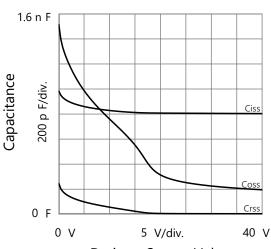
Source to Drain Voltage Body Diode Forward Characteristics



Gate to Source Voltage Transfer Characteristics

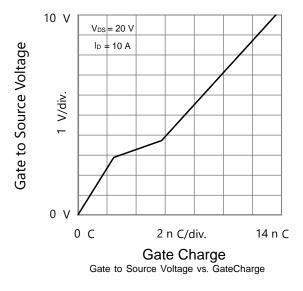


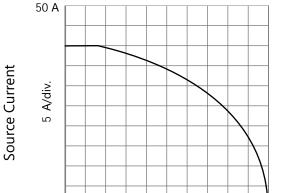
Drain Current
Drain to Source Resistance vs. Drain Current





### TYPICAL CHARACTERISTICS (T<sub>C</sub> = 25 °C, unless otherwise noted)

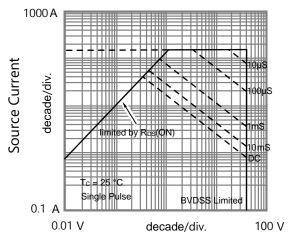




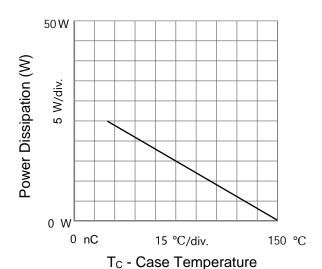
0 A

0 nC

 $$15\,^{\circ}\text{C/div}$.$   $T_{C}$  - Case Temperature



Source to Drain Voltage Safe Operating Area, Junction-to-Ambient



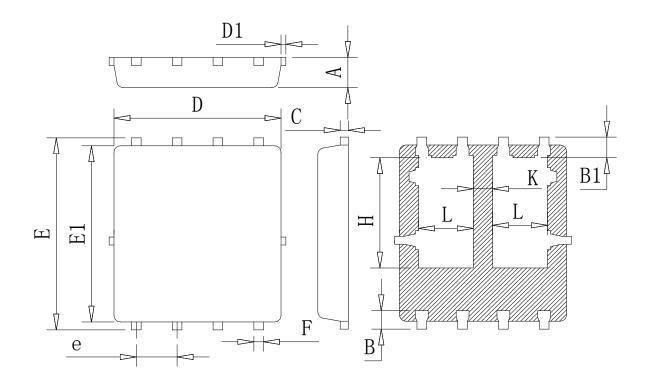
| In descending order | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse | D=0.5, 0.3, 0.1, single pulse | D=0.5, 0.3, 0.1, single pulse | D=0.5, 0.3, 0.1, single pulse | D=0.5, 0.3, single pulse | D=0.5, single pulse

150 °C

Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Case

# **DFN5X6-8L-D PACKAGE OUTLINE**



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Тур	Max
A	0.85	0.95	1.05
В	0.46	0.58	0.73
B1	0.52	0.65	0.78
С	0.18	0.254	0.32
D	4.70	5.20	5.50
D1	-	-	0.18
Е	5.75	6.05	6.35
E1	5.35	5.65	5.85
e	1.15	1.27	1.50
F	0.15	0.30	0.50
Н	3.15	3.47	3.80
L	1.35	1.70	2.10
K	0.35	0.60	1.00

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